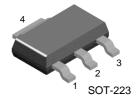


September 2006

# **NZT902 NPN Low Saturation Transistor**

· These devices are designed with high current gain and low saturation voltage with collector currents up to 3A continuous.



1. Base 2. Collector 3. Emitter

### Absolute Maximum Ratings\* Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	90	V
V <sub>CBO</sub>	Collector-Base Voltage	120	V
V <sub>EBO</sub>	Emitter-Base Voltage	5	V
I <sub>C</sub>	Collector Current - Continuous	3	А
$T_J$	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature Range	- 55 ~ +150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

## Thermal Characteristics\* $T_a=25$ °C unless otherwise noted

Symbol	Parameter	Value	Units
$P_D$	Total Device Dissipation	1	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W

<sup>\*</sup> Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm.

### Electrical Characteristics\* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 10mA	90			V
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> = 100μA	120			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_{E} = 100 \mu A$	5			V
I <sub>CBO</sub>	Collector-Base Cutoff Current	V <sub>CB</sub> = 100V V <sub>CB</sub> = 100V, Ta = 100 °C			100 10	nA uA
I <sub>EBO</sub>	Emitter-Base Cutoff Current	V <sub>EB</sub> = 4V			100	nA
h <sub>FE</sub>	DC Current Gain	$I_{C} = 0.1A, V_{CE} = 2V$ $I_{C} = 1A, V_{CE} = 2V$ $I_{C} = 2A, V_{CE} = 2V$	80 80 25			
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_C = 0.1A, I_B = 5.0mA$ $I_C = 1A, I_B = 100mA$ $I_C = 3A, I_B = 300mA$			50 250 600	mV mV mV
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 1A, I <sub>B</sub> = 100mA			1.25	V
C <sub>obo</sub>	Output Capacitance	$V_{CB} = 10V, I_E = 0, f = 1MHz$			35	pF
f <sub>T</sub>	Transition Frequency	$I_C = 100 \text{mA}, V_{CE} = 5 \text{V}, f = 100 \text{MHz}$	75			MHz

<sup>\*</sup> Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

<sup>1)</sup> These ratings are based on a maximum junction temperature of 150°C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

## **Typical Performance Characteristics**

Figure 1. Static Characteristic

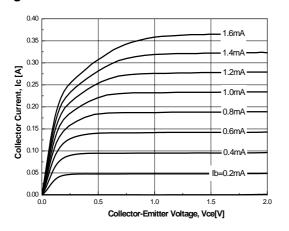


Figure 2. DC current Gain

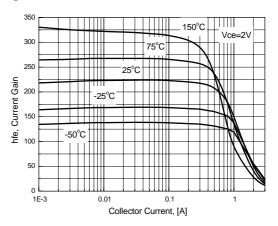


Figure 3. Collector-Emitter Saturation Voltage

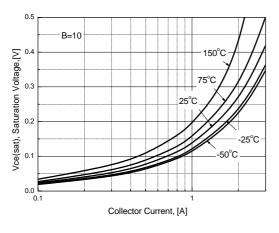


Figure 4. Base-Emitter Saturation Voltage

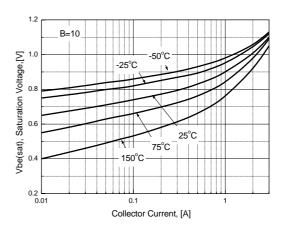


Figure 5. Output Capacitance

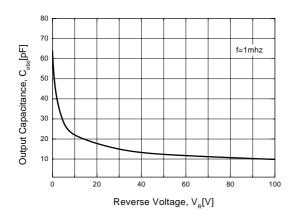
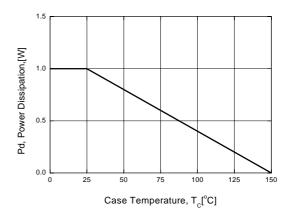


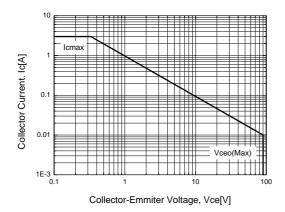
Figure 6. Power Dissipation vs
Ambient Temperature



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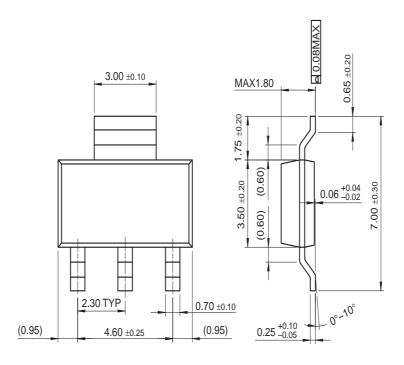
# **Typical Performance Characteristics**

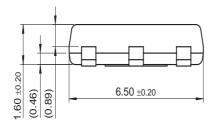
## Figure 9. SOA



### **Mechanical Dimensions**

# **SOT-223**





Dimensions in Millimeters

UltraFET® UniFET™ VCX™ Wire™

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Build it Now™	HiSeC™	OPTOPLANAR™	Stealth™
CoolFET™	I <sup>2</sup> C <sup>TM</sup>	PACMAN™	SuperFET™
CROSSVOLT™	i-Lo <sup>TM</sup>	POP™	SuperSOT™-3
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EnSigna™	LittleFET™	PowerTrench <sup>®</sup>	TCM™
FACT™	MICROCOUPLER™	QFET <sup>®</sup>	TinyBoost™
FAST <sup>®</sup>	MicroFET™	QS™	TinyBuck™
FASTr™	MicroPak™	QT Optoelectronics™	TinyPWM™
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	MSXPro™	RapidConnect™	TINYOPTO™
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